

V <sub>DS</sub>	1200 V
R <sub>DS,on</sub>	4.9 mΩ
I <sub>D (TC=25C)</sub>	348 A
T <sub>J</sub> ,max	175°C

# **QSiC™ 1200V SiC Half-Bridge Module**

#### **Features**

- 62mm footprint with reduced package height (17 mm)
- High speed switching SiC MOSFETs
- · Reliable body diode
- All parts tested to above 1350V
- Kelvin reference for stable operation
- · Isolated baseplate

#### **Benefits**

- Lower inductance from reduced package height
- · Low switching losses
- Low junction to case thermal resistance
- Very rugged and easy mounting
- Direct mounting to heatsink (isolated package)

#### **Applications**

- Photovoltaic and Wind Inverter
- · EV/Battery charger
- Energy storage system
- · High voltage DC to DC converter
- Induction Heating
- SMPS and UPS

#### **Package**



Part #	Package	Marking
GCMX005A120S7B1	<b>S</b> 7	GCMX005A120S7B1



## Absolute Maximum Ratings, at T<sub>J</sub>=25°C, unless otherwise specified

Characteristics	Symbol	Conditions	Values	Unit
Drain-Source Voltage	V <sub>rated</sub>	$V_{GS}$ =0V, $I_D$ =1 $\mu$ A	1200	V
Continuous Drain Current	1	T <sub>C</sub> =25°C, V <sub>GS</sub> =20V, T <sub>J</sub> =175°C	348	
Continuous Diam Current	I <sub>DS</sub>	T <sub>C</sub> =65°C, V <sub>GS</sub> =20V, T <sub>J</sub> =175°C	301	Α
Body Diode Drain Current	I <sub>SD</sub>	T <sub>C</sub> =25°C, V <sub>GS</sub> =-5V, T <sub>J</sub> =175°C	271	_ A
Pulsed Drain Current	I <sub>DS,pulse</sub>	T <sub>C</sub> =25°C, V <sub>GS</sub> =20V	700	
Cata Sauraa Valtaga	$V_{GSmax}$		-10/25	V
Gate Source Voltage	$V_{GSop}$	Recommended operational	-5/20	V
Power Dissipation	P <sub>tot</sub>	T <sub>C</sub> =25°C, T <sub>J</sub> =175°C	1042	W
Junction Temperature	T <sub>J</sub>	Continuous	-40175	°C
Case & Storage Temperature	T <sub>C</sub> , T <sub>storage</sub>	Continuous	-40150	°C

## GCMX005A120S7B1

## Static Electrical Characteristics, at $T_J$ =25°C, unless otherwise specified

Characteristics	Symbol	Conditions	Values			Unit
Characteristics	Syllibol	Conditions	min.	typ.	max.	Oilit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =1mA	1200	-	-	V
Zero Gate Voltage Drain Current	1	V <sub>DS</sub> =1200V, V <sub>GS</sub> =0V	-	0.4	4	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =1200V, V <sub>GS</sub> =0V, T <sub>J</sub> =150°C	-	1	400	μA
Gate-Source Leakage Current	I <sub>GSS+</sub>	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V	-	40	1000	nA
Gale-Source Leakage Current	I <sub>GSS-</sub>	V <sub>GS</sub> =-5V, V <sub>DS</sub> =0V	-	-40	-1000	IIA
Cata Throshold Voltage	W	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =80mA	1.8	3.1	4	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}$ , $I_D=80$ mA, $T_J=150$ °C	-	2.3	-	\ \ \
	R <sub>DSon</sub> *	V <sub>GS</sub> =20V, I <sub>D</sub> =200A	-	4.9	7	mΩ
Drain-Source On-Resistance		V <sub>GS</sub> =20V, I <sub>D</sub> =100A	-	4.8	-	
		V <sub>GS</sub> =20V, I <sub>D</sub> =200A, T <sub>J</sub> =150°C	-	7.2	-	
Transpenductores	g <sub>fs</sub>	V <sub>DS</sub> =20V, I <sub>D</sub> =200A	-	97.3	-	S
Transconductance		V <sub>DS</sub> =20V, I <sub>D</sub> =200A, T <sub>J</sub> =150°C	-	109.2	-	3
		f=1MHz, V <sub>AC</sub> =25mV, D-S Short,				
Internal Gate Resistance	$R_{G(int)}$	including internal 1.25 ohm series gate resistor**	-	1.5	-	Ω

<sup>\*</sup>R<sub>DSon</sub> including package resistance

## AC Electrical Characteristics, at T<sub>J</sub>=25°C, unless otherwise specified

Characteristics	Cumbal	Conditions		Values		Unit
Characteristics	Symbol	Conditions	min.	typ.	max.	Offic
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V	-	29.3	-	
Output Capacitance	Coss	V <sub>DS</sub> =800V	-	1.24	-	nF
Reverse Transfer Capacitance	C <sub>RSS</sub>	f=200kHz	-	0.07	-	
Coss Stored Energy	E <sub>oss</sub> ***	Vac=25mV	-	472	-	μJ
		T <sub>J</sub> =25°C	-	2.59	-	
Turn-On Switching Energy	E <sub>ON</sub>	$T_{J}=125^{\circ}C$ $V_{DD}=600V$ ,	-	3.01	-	
		T <sub>J</sub> =150°C   I <sub>DS</sub> =200A,	-	3.16	-	m.l.
		$T_J = 25^{\circ}C$ $R_{G(ext)} = 1\Omega$ , $V_{GS} = -5/+20V$ ,	-	1.11	-	mJ
Turn-Off Switching Energy	E <sub>OFF</sub>	T <sub>J</sub> =125°C	-	1.15	-	
		T <sub>J</sub> =150°C	-	1.18	-	
Turn-On Delay Time	t <sub>D(on)</sub>	1/ 000// 0004	-	53	-	
Rise Time	t <sub>R</sub>	V <sub>DD</sub> =600V, I <sub>DS</sub> =200A,	-	16	-	
Turn-Off Delay Time	t <sub>D(off)</sub>	-R <sub>G(ext)</sub> =1Ω, V <sub>GS</sub> =-5V/20V, -L=90μH	-	94	-	ns
Fall Time	t <sub>F</sub>	- 20μπ	-	26	-	
Total Gate Charge	$Q_{G}$	V =800V L =200A	-	913	-	
Gate to Source Charge	Q <sub>GS</sub>	-V <sub>DD</sub> =800V, I <sub>DS</sub> =200A -V <sub>GS</sub> =-5/20V	-	325	-	nC
Gate to Drain Charge	$Q_{GD}$	- V <sub>GS</sub> 3/20V	-	166	-	

<sup>\*\*\*</sup>E<sub>OSS</sub> is calculated from C<sub>OSS</sub> curve

<sup>\*\*</sup>Internal series gate resistor limits maximum switching frequency defined by Figure 31

## GCMX005A120S7B1

## Freewheeling Diode Characteristics, at T<sub>J</sub>=25°C, unless otherwise specified

Characteristics	Symbol	Conditions			Values		Unit															
Characteristics	Syllibol	Col	Conditions		typ.	max.	Oint															
Diode Forward Voltage	$V_{SD}$	$V_{GS}$ =-5V, $I_{S}$ =2		-	4.1	1	V															
Blode i diward voltage	V SD	$V_{GS}$ =-5V, $I_{S}$ =2	00A, T <sub>J</sub> =150°C	-	3.6	ı	V															
Reverse Recovery Time	$t_{RR}$	T <sub>J</sub> =25°C	$T_J=25^{\circ}C$ $V_R=V_{GS}$	I <sub>S</sub> =200A,	-	21	ı	ns														
Reverse Recovery Charge	$Q_{RR}$			$T_J$ =25°C $V_R$ =600V, $V_{GS}$ =-5V, di/dt=16.9A/ns	T <sub>J</sub> =25°C	V <sub>R</sub> =600V, V <sub>GS</sub> =-5V,	-	2346	ı	nC												
Peak Reverse Recovery Current	$I_{RRM}$					-	188	1	Α													
		T <sub>J</sub> =25°C	I <sub>S</sub> =200A,	-	0.84	-																
Reverse Recovery Energy	-	1.73	-	mJ																		
				-	2.06	-																

## Thermal and Package Characteristics, at $T_j$ =25 °C, unless otherwise specified

Characteristics	Symbol	ool Conditions	Values			Unit
Characteristics	Symbol		min.	typ.	max.	Oilit
Thermal resistance, junction-case	R <sub>thJC</sub>		-	0.129	0.144	°C/W
Mounting torque	M <sub>d</sub>	M6-1.0 screws	-	-	5.0	N-m
Terminal connection torque	M <sub>dt</sub>	M5-0.8 screws	-	-	5.0	N-m
Package weight	W <sub>t</sub>		-	250	-	g
Isolation voltage	V <sub>ISOL</sub>	I <sub>ISOL</sub> < 1mA,50/60 Hz, 1 min	4000	-	-	V

## NTC Characteristics, at $T_j$ =25 °C, unless otherwise specified

Characteristics	Symbol	Symbol Conditions	Values			Unit
Cital acteristics	Syllibol	Conditions	min.	typ.	max.	Oilit
Rated resistance	$R_{NTC}$	$T_{NTC} = 25^{\circ}C$	-	5.0	-	kΩ
Resistance tolerance	ΔR/R		-5	-	5	%
Beta Value (T <sub>2</sub> = 50°C)	β <sub>25/50</sub>		-	3380	-	k
Beta Value (T <sub>2</sub> = 80°C)	β <sub>25/80</sub>		-	3440	-	k
Power dissipation	P <sub>MAX</sub>	T <sub>NTC</sub> = 25°C	-	-	50	mW

## **Typical Performance**

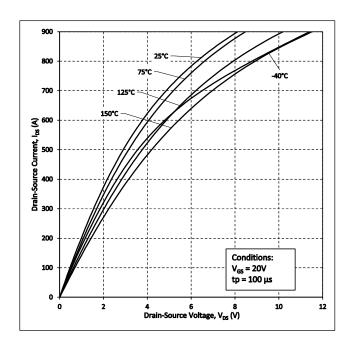


Figure 1. Output Characteristics for Various Temperatures

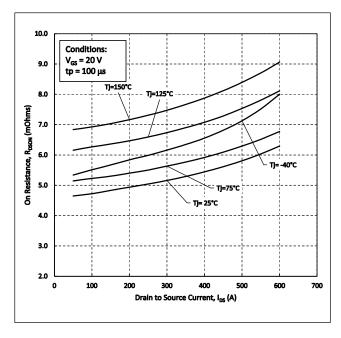


Figure 3. On-Resistance vs. Drain Current For Various Temperatures

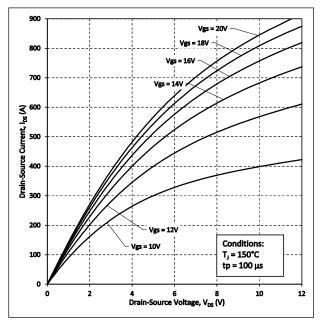


Figure 2. Output Characteristics T<sub>J</sub> = 150°C

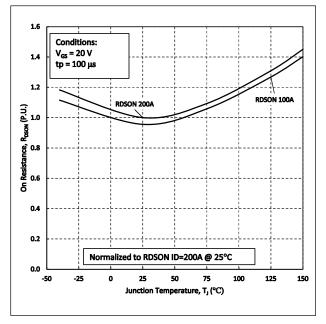
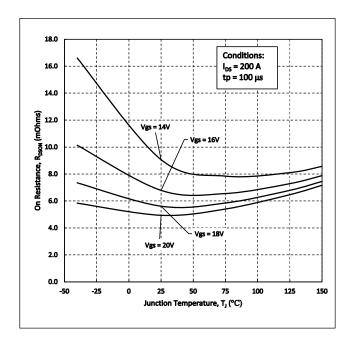


Figure 4. Normalized On-Resistance vs. Temperature

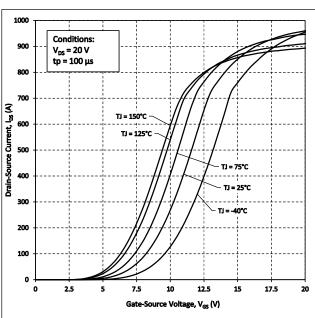


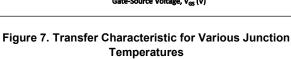
4.5
4.0
3.5
4.0
3.5

Section 1.0
0.5
0.0
-50
-25
0
25
50
75
100
125
150
Junction Temperature, T, (°C)

Figure 5. On-Resistance vs. Temperature For Various Gate Voltages

Figure 6. Threshold Voltage vs. Temperature





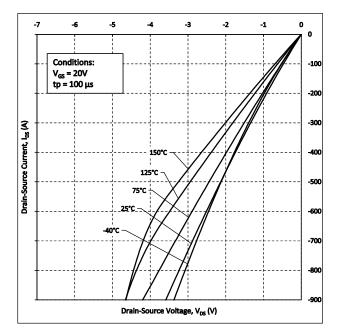


Figure 8.  $3^{rd}$  Quadrant Characteristics at  $V_{GS} = 20V$ 

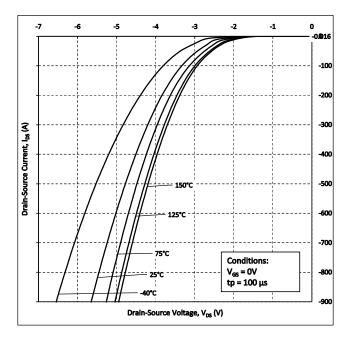
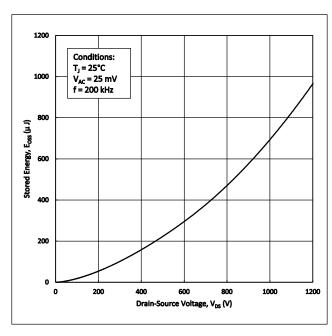


Figure 9. Body Diode Characteristics at  $V_{GS} = 0V$ 

Figure 10. Body Diode Characteristics at  $V_{GS} = -5V$ 



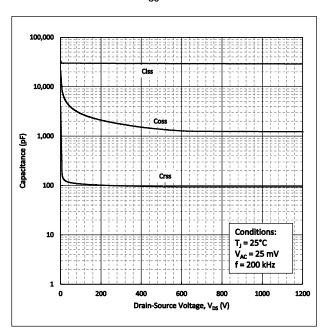
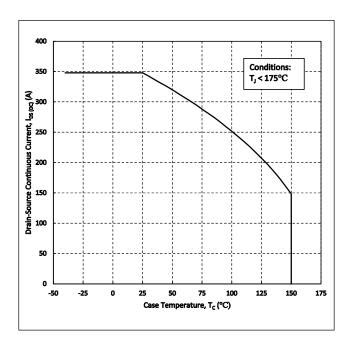


Figure 11. Output Capacitor Stored Energy

Figure 12. Capacitance vs. Drain-Source Voltage



1200

1000

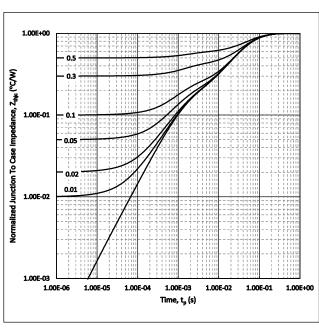
Conditions:
T<sub>1</sub> < 175°C

See Temperature, T<sub>c</sub> (°C)

Figure 13. Continuous Drain Current Derating vs. Case Temperature

Figure 14. Maximum Power Dissipation Derating vs.

Case Temperature



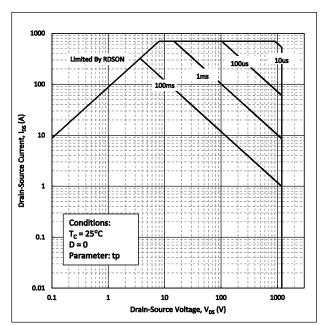
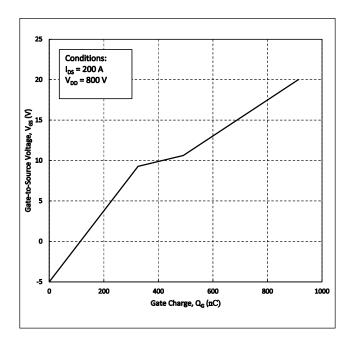


Figure 15. Transient Thermal impedance (Junction to Case)

Figure 16. Safe Operating Area



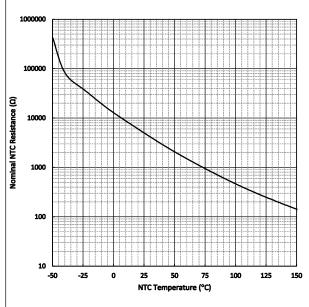


Figure 17. Gate Charge Characteristics

Figure 18. Nominal NTC Resistance vs. Temperature

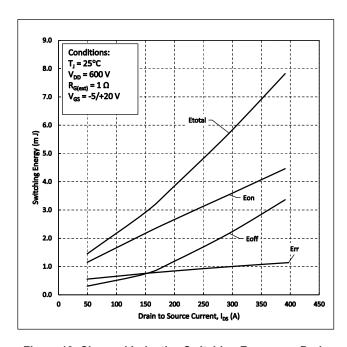


Figure 19. Clamped Inductive Switching Energy vs. Drain Current (600V)

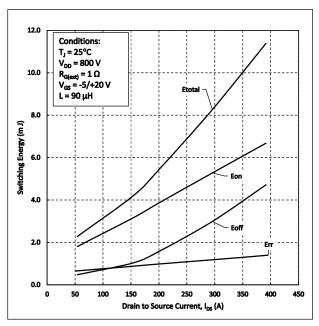
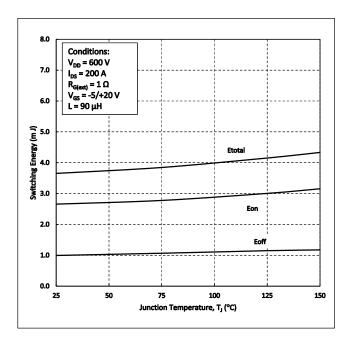


Figure 20. Clamped Inductive Switching Energy vs.
Drain Current (800V)



3.0

Conditions:

I<sub>DS</sub> = 200 A

R<sub>e(ext)</sub> = 1 Ω

V<sub>eS</sub> = -5/+20 V

L = 90 μH

Err (Vdd = 800V)

Err (Vdd = 600V)

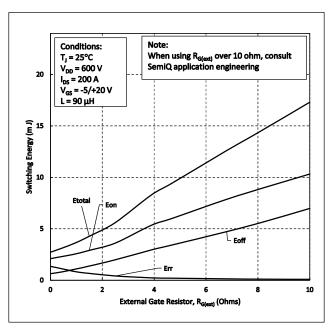
1.0

0.5

Junction Temperature, T<sub>1</sub> (°C)

Figure 21. Clamped Inductive Switching Energy vs.
Temperature

Figure 22. Reverse Recovery Energy vs. Temperature



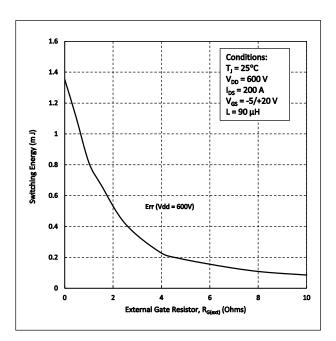
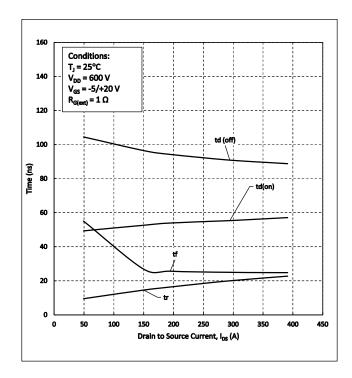


Figure 23. Clamped Inductive Switching Energy vs.  $R_{G(ext)}$ 

Figure 24. Reserve Recovery Energy vs.  $R_{G(ext)}$ 



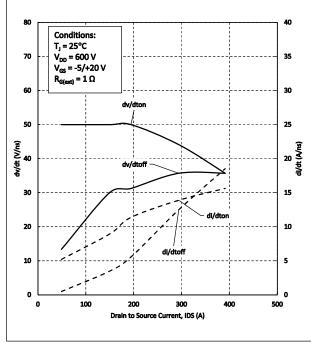
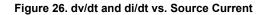
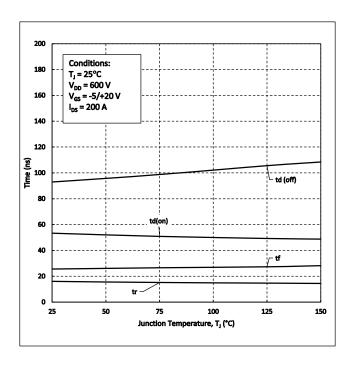


Figure 25. Switching Times vs. Drain Current







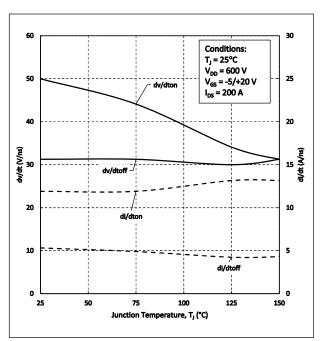
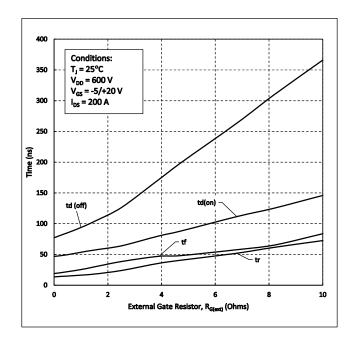


Figure 28. dv/dt and di/dt vs. Temperature



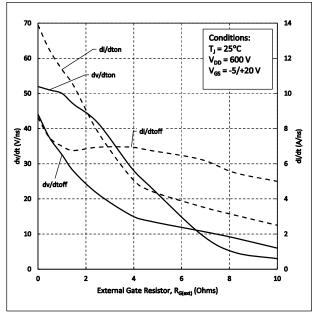
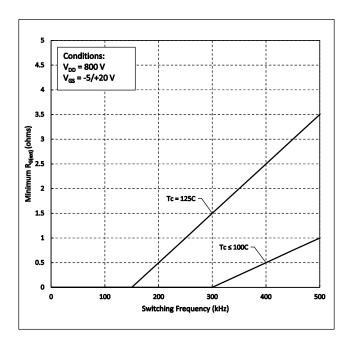
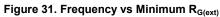


Figure 29. Switching Times vs.  $R_{G(ext)}$ 

Figure 30. dv/dt and di/dt vs.  $R_{\text{G(ext)}}$ 





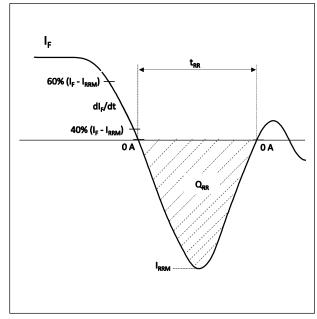


Figure 32. Reverse Recovery Definitions

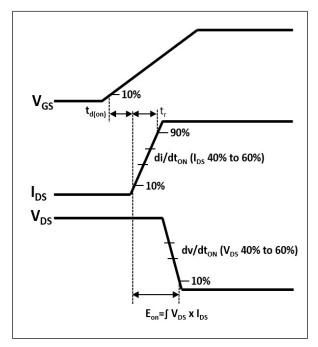


Figure 33. Turn-on Transient Definitions

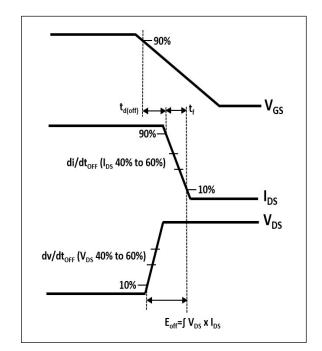
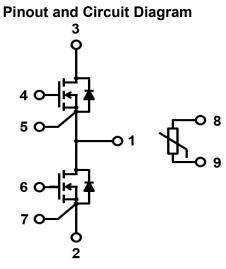
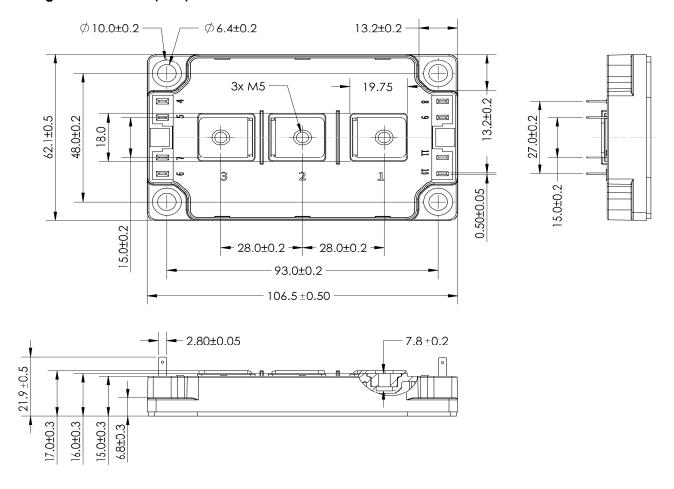


Figure 34. Turn-off Transient Definitions



## Package Dimensions (mm)



#### GCMX005A120S7B1

	Revision History					
Date	Revision	Notes				
10/31/2023	0.1	Preliminary release				
11/10/2023	1.0	Initial release				
5/8/2024	1.1	Updated logo and isolation testing, updated Zth				
8/21/2024	1.2	Updated switching loss				
11/14/2024	1.3	Updated thermals, typos				

#### **Notes**

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.SemiQ.com.

#### REACh Compliance

REACh substances of high concern (SVHC) information is available for this product. Since the European Chemicals Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact our office at SemiQ Headquarters in Lake Forest, California to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

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